

# 2MBI100N-120

IGBT Module

1200V / 100A 2 in one-package

## ■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

## ■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines



## ■ Maximum ratings and characteristics

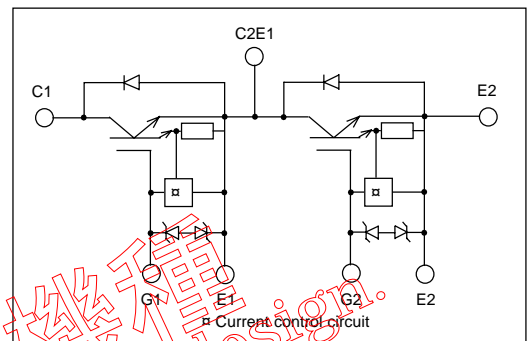
### ● Absolute maximum ratings (at $T_c=25^{\circ}\text{C}$ unless otherwise specified)

Item	Symbol	Rating	Unit
Collector-Emitter voltage	$V_{CES}$	1200	V
Gate-Emitter voltage	$V_{GES}$	$\pm 20$	V
Collector current	Continuous	$I_c$	100 A
	1ms	$I_c$ pulse	200 A
	Continuous	$-I_c$	100 A
	1ms	$-I_c$ pulse	200 A
Max. power dissipation	$P_c$	780	W
Operating temperature	$T_j$	+150	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$	-40 to +125	$^{\circ}\text{C}$
Isolation voltage	$V_{is}$	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *2	4.5	N·m

\*1 : Recommendable value : 2.5 to 3.5 N·m(M5) or (M6)

\*2 : Recommendable value : 3.5 to 4.5 N·m(M6)

### ■ Equivalent Circuit Schematic



### ● Electrical characteristics (at $T_j=25^{\circ}\text{C}$ unless otherwise specified)

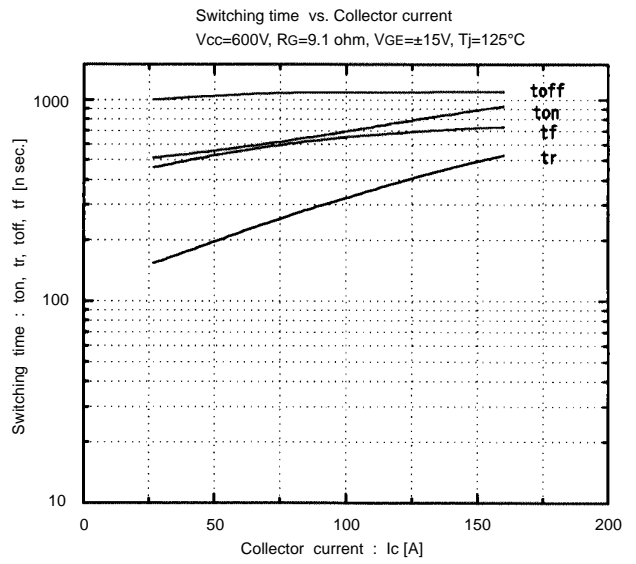
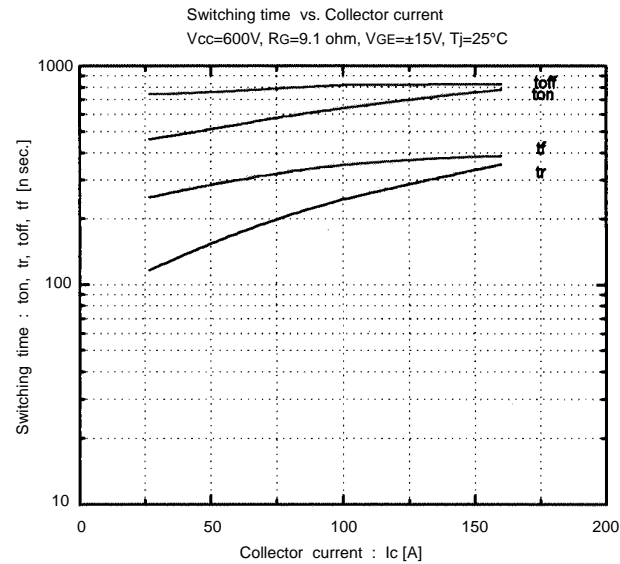
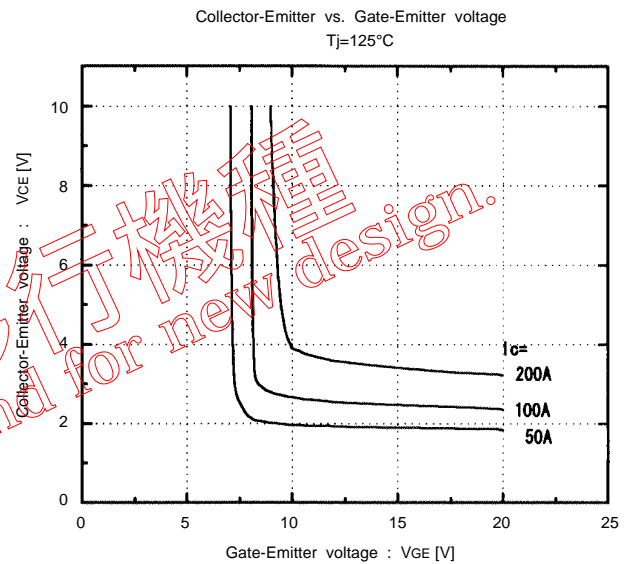
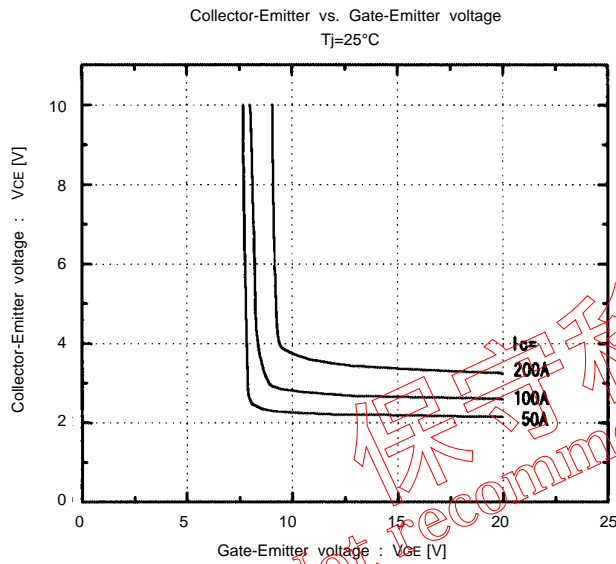
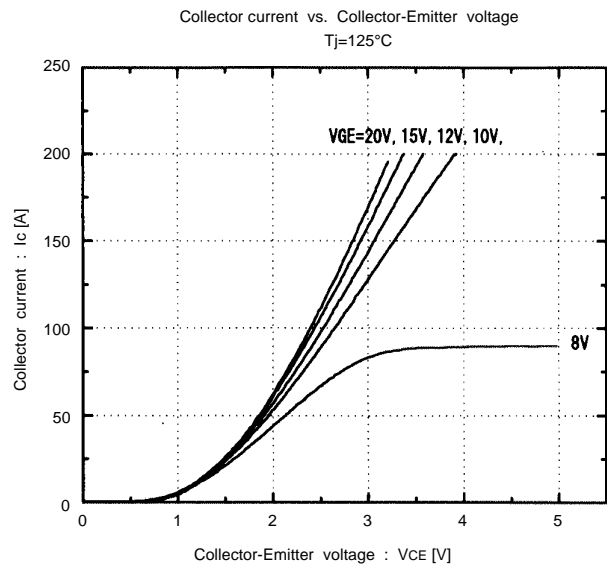
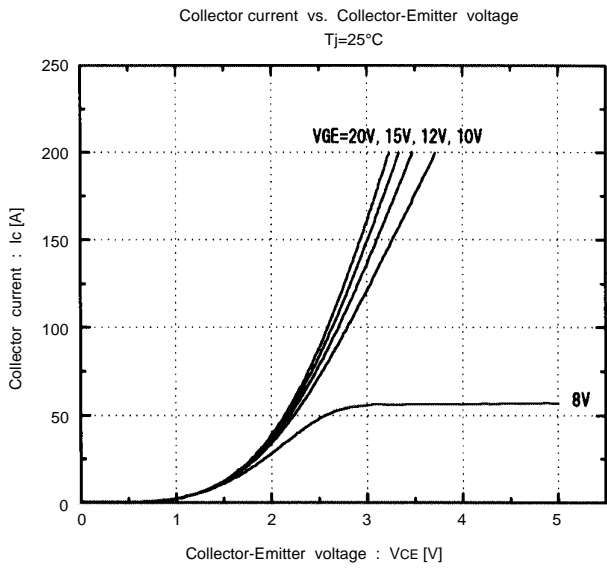
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	$I_{CES}$	—	—	2.0	$V_{GE}=0\text{V}$ , $V_{CE}=1200\text{V}$	mA
Gate-Emitter leakage current	$I_{GES}$	—	—	30	$V_{CE}=0\text{V}$ , $V_{GE}=\pm 20\text{V}$	$\mu\text{A}$
Gate-Emitter threshold voltage	$V_{GE(th)}$	4.5	—	7.5	$V_{CE}=20\text{V}$ , $I_c=100\text{mA}$	V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	—	—	3.3	$V_{GE}=15\text{V}$ , $I_c=100\text{A}$	V
Input capacitance	$C_{ies}$	—	16000	—	$V_{GE}=0\text{V}$	pF
Output capacitance	$C_{oes}$	—	5800	—	$V_{CE}=10\text{V}$	
Reverse transfer capacitance	$C_{res}$	—	5160	—	$f=1\text{MHz}$	
Turn-on time	$t_{on}$	—	0.65	1.2	$V_{CC}=600\text{V}$	$\mu\text{s}$
	$t_r$	—	0.25	0.6	$I_c=100\text{A}$	
Turn-off time	$t_{off}$	—	0.85	1.5	$V_{GE}=\pm 15\text{V}$	$\mu\text{s}$
	$t_f$	—	0.35	0.5	$R_G=9.1\text{ ohm}$	
Diode forward on voltage	$V_F$	—	—	3.0	$I_F=100\text{A}$ , $V_{GE}=0\text{V}$	V
Reverse recovery time	$t_{rr}$	—	—	0.35	$I_F=100\text{A}$	$\mu\text{s}$

### ● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	$R_{th(j-c)}$	—	—	0.16	IGBT	$^{\circ}\text{C/W}$
	$R_{th(j-c)}$	—	—	0.43	Diode	$^{\circ}\text{C/W}$
	$R_{th(c-f)*3}$	—	0.025	—	the base to cooling fin	$^{\circ}\text{C/W}$

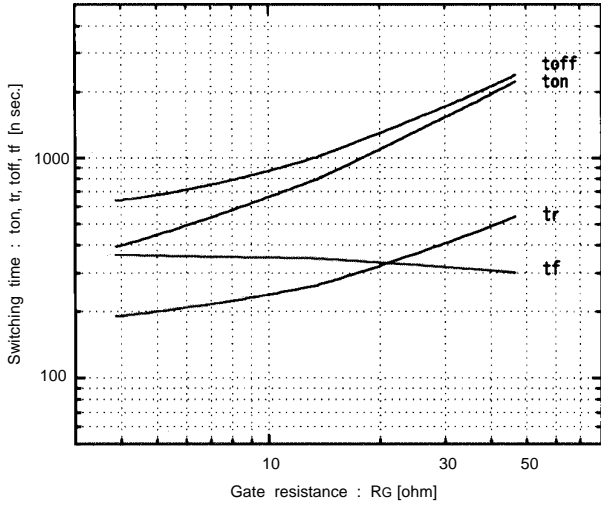
\*3 : This is the value which is defined mounting on the additional cooling fin with thermal compound

■ Characteristics (Representative)

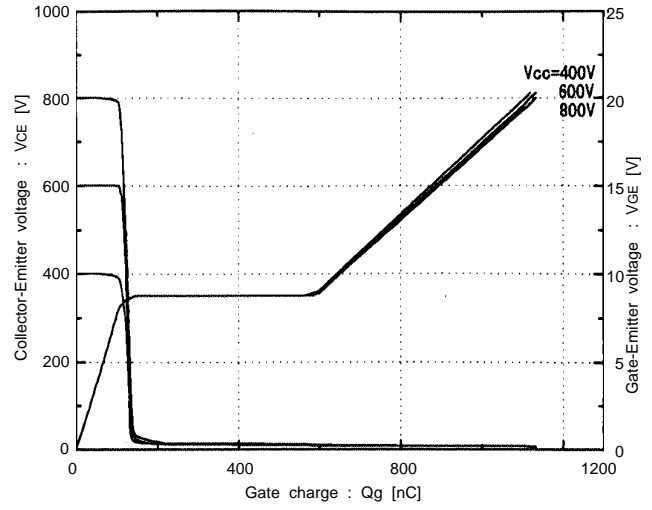


保潔移打機福  
 Not recommend for new design.

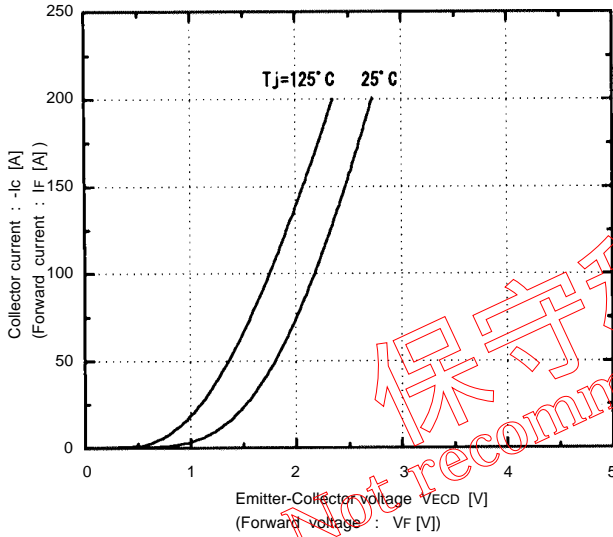
Switching time vs. RG  
Vcc=600V, Ic=100A, VGE=±15V, Tj=25°C



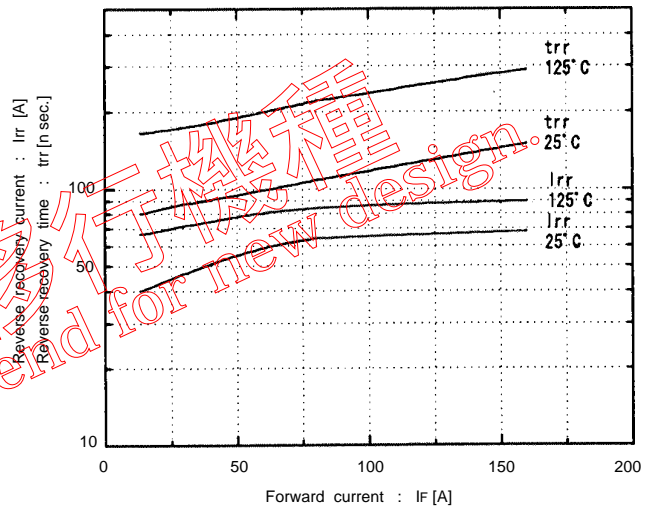
Dynamic input characteristics  
Tj=25°C



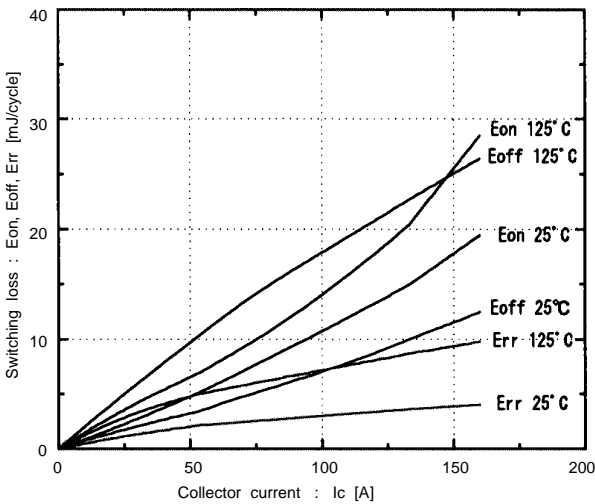
Forward current vs. Forward voltage  
VGE=0V



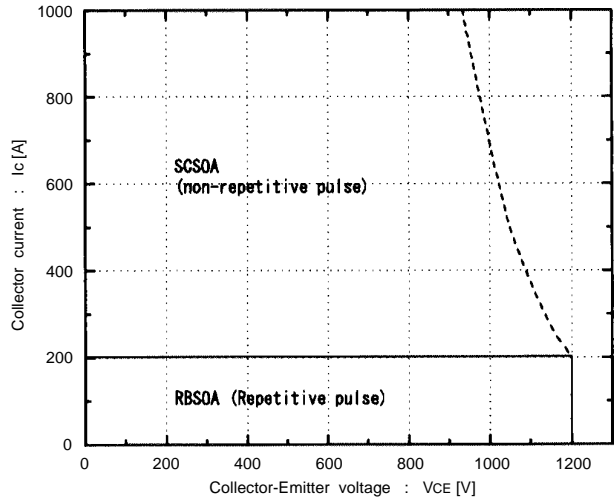
Reverse recovery characteristics  
trr, Irr, vs. IF

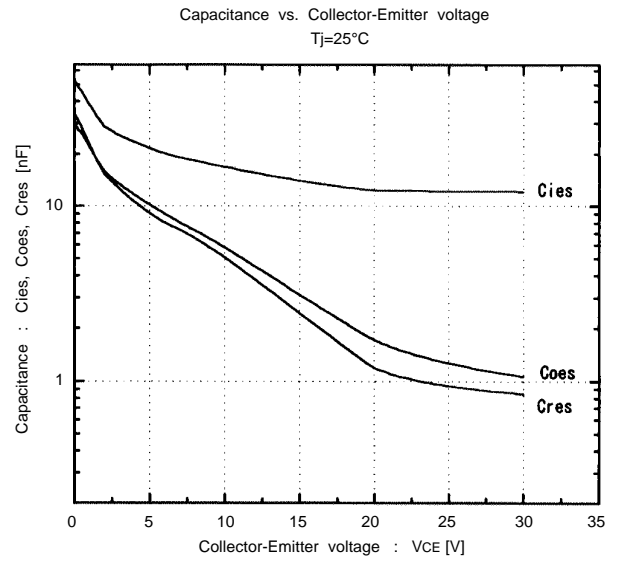
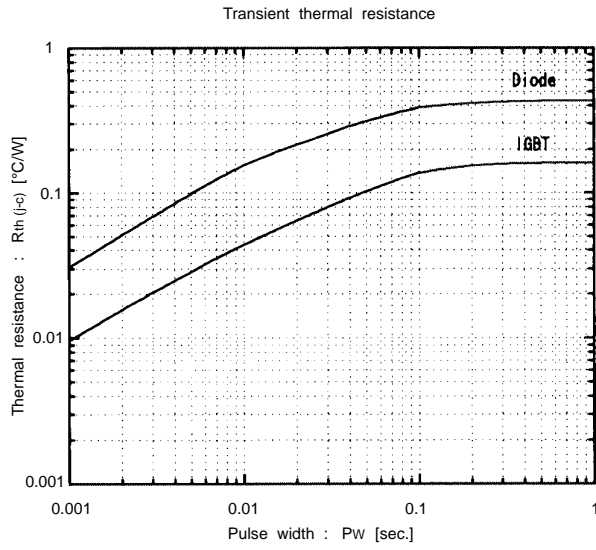


Switching loss vs. Collector current  
Vcc=600V, RG=9.1 ohm, VGE=±15V



Reversed biased safe operating area  
+VGE=15V, -VGE ≤ 15V, Tj ≤ 125°C, RG ≥ 9.1 ohm





■ Outline Drawings, mm

